

NCE N-Channel Super Trench II Power MOSFET

Description

The NCEP065N10GU uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

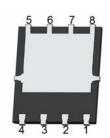
General Features

- V_{DS} =100V,I_D =90A
 - $R_{DS(ON)}$ =5.9m Ω (typical) @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

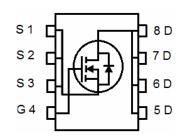
DFN 5X6





Top View

Bottom View



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P065N10GU	NCEP065N10GU	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	90	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	65	А
Pulsed Drain Current	I _{DM}	360	Α
Maximum Power Dissipation	P _D	110	W
Derating factor		0.88	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	380	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ heta JC}$	1.14	°C/W

NCEP065N10GU

Electrical Characteristics (T_C=25 °C unless otherwise noted)

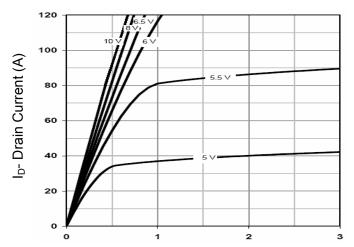
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	<u> </u>			•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =45A	-	5.9	6.5	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =45A		60	-	S
Dynamic Characteristics (Note4)	<u> </u>					
Input Capacitance	C _{lss}	V _{DS} =50V,V _{GS} =0V,	-	3600	-	PF
Output Capacitance	C _{oss}		-	335	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	19.5	-	PF
Switching Characteristics (Note 4)	<u> </u>					
Turn-on Delay Time	t _{d(on)}		-	17	-	nS
Turn-on Rise Time	t _r	V_{DD} =50 V , I_D =45 A ,	-	11	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	36	-	nS
Turn-Off Fall Time	t _f		-	9	-	nS
Total Gate Charge	Qg	\/ _E0\/	-	60	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=50V,I_{D}=45A,$	-	20		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	15		nC
Drain-Source Diode Characteristics				•		
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =45A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	90	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =45A	-	62	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	109	-	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\!\!\mathrm{C}$,V $_{DD}$ =50 V ,V $_{G}$ =10 V ,L=0.5 mH ,Rg=25 Ω

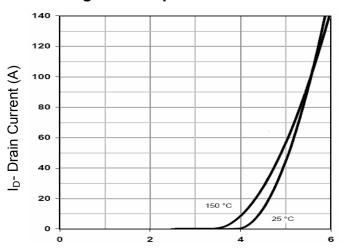


Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)





Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

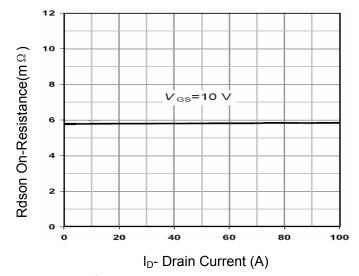


Figure 3 Rdson- Drain Current

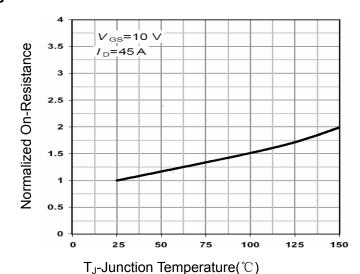


Figure 4 Rdson-Junction Temperature

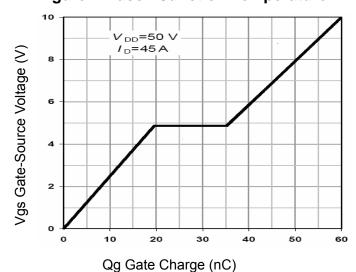


Figure 5 Gate Charge

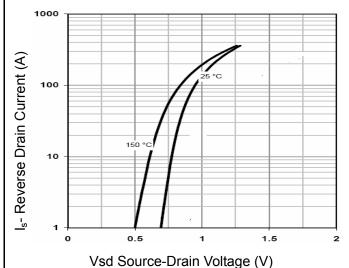
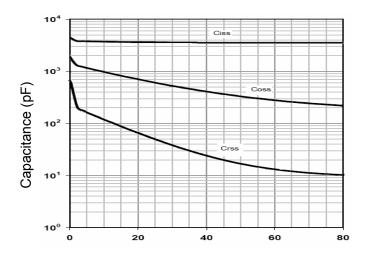
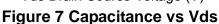


Figure 6 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)



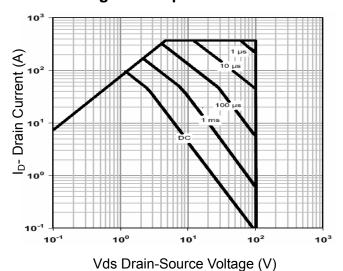
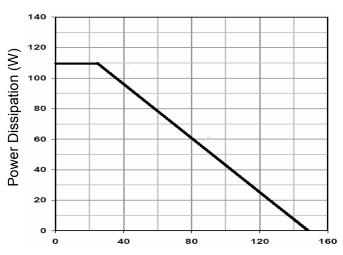
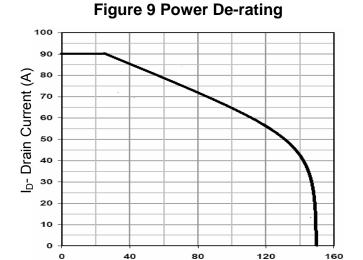


Figure 8 Safe Operation Area



 T_J -Junction Temperature($^{\circ}$ C)



T_J-Junction Temperature (°C)

Figure 10 Current De-rating

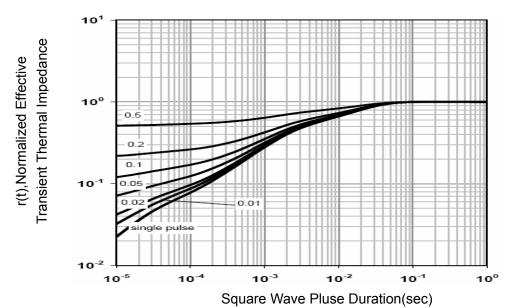
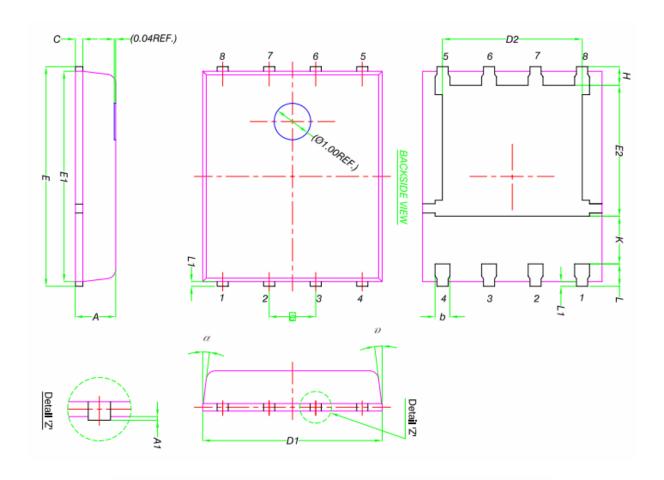


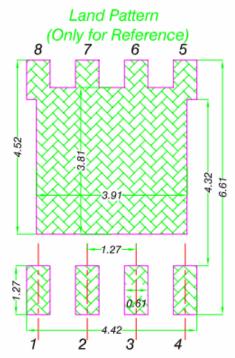
Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



DIM.	MILLIMETERS			
	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
К	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	<i>0</i> °	-	12°	



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NCEP065N10GU

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